# International IOR Rectifier

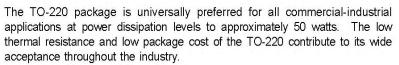
# IRL630PbF

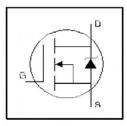
### HEXFET® Power MOSFET

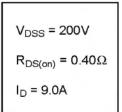
- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- $R_{DS(ON)}$  Specified at  $V_{GS} = 4V \& 5V$
- 150°C Operating Temperature
- **Fast Switching**
- Ease of paralleling
- Lead-Free

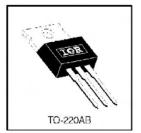
### Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low onresistance and cost-effectiveness.









### **Absolute Maximum Ratings**

	Parameter	Max.	Units
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V GS @ 5.0V	9.0	
I <sub>D</sub> @ T <sub>C</sub> = 100°C	Continuous Drain Current, V GS @ 5.0V	5.7	Α
I <sub>DM</sub>	Pulsed Drain Current ①	36	
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Power Dissipation	74	W
	Linear Derating Factor	0.59	W/°C
V <sub>GS</sub>	Gate-to-Source Voltage	±10	V
E <sub>AS</sub>	Single Pulse Avalanche Energy 2	250	mJ
I <sub>AR</sub>	Avalanche Current ①	9.0	А
E <sub>AR</sub>	Repetitive Avalanche Energy ①	7.4	mJ
d∨/dt	Peak Diode Recovery dv/dt 3	5.0	V/ns
TJ	Operating Junction and	-55 to + 150	
T <sub>STG</sub>	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting torque, 6-32 or M3 screw.	10 lbf•in (1.1N•m)	

### Thermal Resistance

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	Parameter	Min.	Тур.	Max.	Units
R <sub>θ</sub> JC	Junction-to-Case		-	1.7	
R <sub>BCS</sub>	Case-to-Sink, Flat, Greased Surface	·	0.50	-	°C/W
R <sub>θJA</sub>	Junction-to-Ambient			62	

8/24/04

### Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	200	_	_	V	V <sub>GS</sub> = 0V, ID = 250µA
ΔV(BR)DSS/ΔTJ	Breakdown Voltage Temp. Coefficient	-	0.27	-	V/°C	Reference to 25°C, I D = 1mA
D	G. F. D. J. J. C		-	0.40	Ω	V <sub>GS</sub> = 5.0V, I <sub>D</sub> = 5.4A <b>②</b>
R <sub>DS(ON)</sub>	Static Drain-to-Source On-Resistance	_	-	0.50	32	V <sub>GS</sub> = 4.0V, I <sub>D</sub> = 4.5A <b>②</b>
V <sub>GS(th)</sub>	Gate Threshold Voltage	1.0	-	2.0	٧	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
<b>g</b> fs	Forward Transconductance	4.8	-	-	S	$V_{DS} = 50V, I_{D} = 5.4A$
1	Desire to Course I colored Course	1 -	-	25	μА	V <sub>DS</sub> = 200V, V <sub>GS</sub> = 0V
DSS	Drain-to-Source Leakage Current	_	—	250	μA	V <sub>DS</sub> = 160V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 125°C
i de la companya de	Gate-to-Source Forward Leakage		_	100	А	V <sub>GS</sub> = 10V
GSS	Gate-to-Source Reverse Leakage		-	-100	nA	V <sub>GS</sub> = -10V
$Q_g$	Total Gate Charge		-	40		I <sub>D</sub> = 9.0A
Q <sub>gs</sub>	Gate-to-Source Charge		_	5.5	nC	V <sub>DS</sub> = 160V
Q <sub>gd</sub>	Gate-to-Drain ("Miller") Charge	1	-	24		V <sub>GS</sub> = 10V, See Fig. 6 and 13 <b>④</b>
t <sub>d(on)</sub>	Turn-On Delay Time	1	8.0	-	ns	V <sub>DD</sub> = 100V
tr	Rise Time	_	57	_	115	I <sub>D</sub> = 9.0A
t <sub>d(off)</sub>	Turn-Off Delay Time	_	38	—		$R_G = 6.0\Omega$
t <sub>f</sub>	Fall Time		33	5		$R_D = 11\Omega$ , See Fig. 10 <b>4</b>
L <sub>D</sub>	Internal Drain Inductance		4.5	_	-11	Between lead, 6mm (0.25in.)
L <sub>S</sub>	Internal Source Inductance	-	7.5	-	· nH	from package and center of die contact
Ciss	Input Capacitance	1	1100	-		V <sub>GS</sub> = 0V
Coss	Output Capacitance	1	220	-	pF	V <sub>DS</sub> = 25V
C <sub>rss</sub>	Reverse Transfer Capacitance	-	70	_		f = 1.0MHz, See Fig. 5

### Source-Drain Ratings and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
ls	Continuous Source Current (Body Diode)		_	9.0		MOSFET symbol showing the
I <sub>SM</sub>	Pulsed Source Current (Body Diode) ①	-	_	36	A	integral reverse p-n junction diode.
$V_{\text{SD}}$	Diode Forward Voltage		.—.	2.0	V	T <sub>J</sub> = 25°C, I <sub>S</sub> = 9.0A, V <sub>GS</sub> = 0V <b>④</b>
t <sub>rr</sub>	Reverse Recovery Time	— ( — /	230	350	ns	T <sub>J</sub> = 25°C, I <sub>F</sub> = 9.0A
Q <sub>rr</sub>	Reverse Recovery Charge		1.7	2.6	μC	di/dt = 100A/µs <b>④</b>
t <sub>on</sub>	Forward Turn-On Time	Intri	Intrinsic turn-on time is negligible (turn-on is dominated by L S+LD)			

#### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 11 )
- $\label{eq:loss_def} \begin{array}{l} \text{ (3)} \ I_{\text{SD}} \leq 9.0 A, \ di/dt \leq 120 \text{A/µs}, \ V_{\text{DD}} \leq V_{(\text{BR})\text{DSS}}, \\ T_{\text{J}} \leq 150 ^{\circ}\text{C} \end{array}$
- $extbf{Q}$  V<sub>DD</sub> = 25V, starting T  $_{
  m J}$  = 25°C, L = 4.6mH R  $_{
  m G}$  = 25 $\Omega$ , I $_{
  m AS}$  = 9.0A. (See Figure 12)
- **4** Pulse width  $\leq 300 \mu s$ ; duty cycle  $\leq 2\%$ .

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# International Rectifier

# IRL630PbF

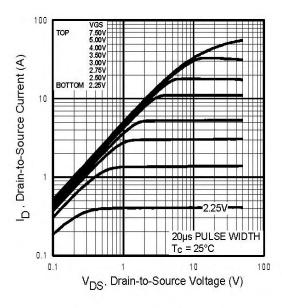


Fig 1. Typical Output Characteristics,  $T_C = 25^{\circ}C$ 

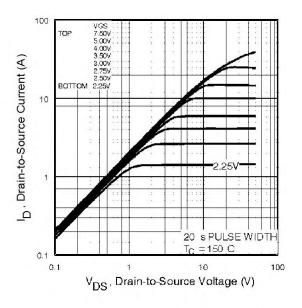


Fig 2. Typical Output Characteristics, T<sub>C</sub> = 150℃

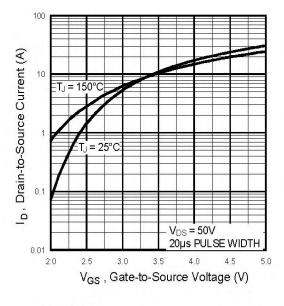


Fig 3. Typical Transfer Characteristics

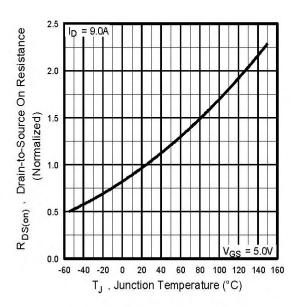
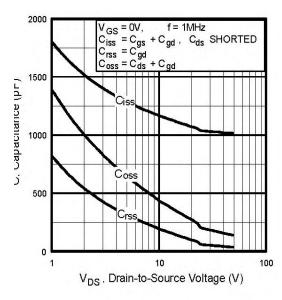
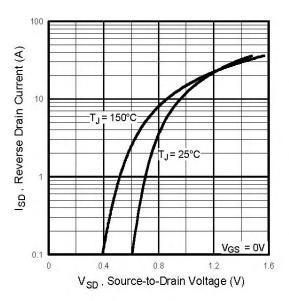


Fig 4. Normalized On-Resistance Vs. Temperature

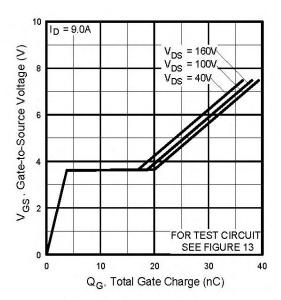
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**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode Forward Voltage



**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage

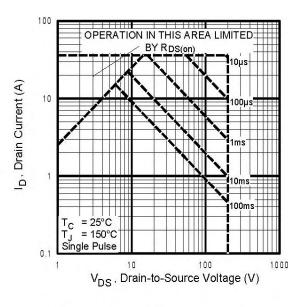


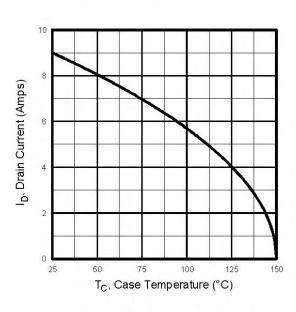
Fig 8. Maximum Safe Operating Area

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**Fig 9.** Maximum Drain Current Vs. Case Temperature

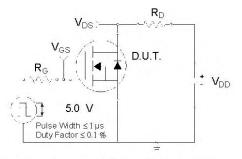


Fig 10a. Switching Time Test Circuit

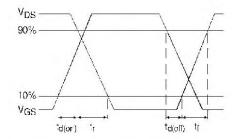


Fig 10b. Switching Time Waveforms

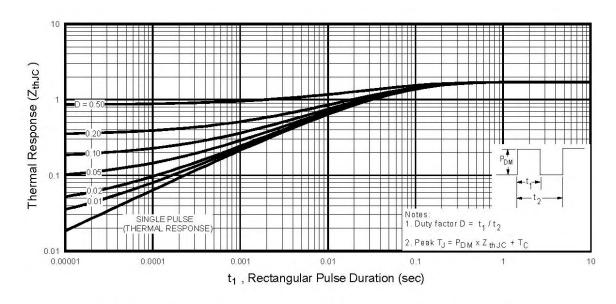


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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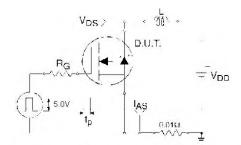


Fig 12a. Unclamped Inductive Test Circuit

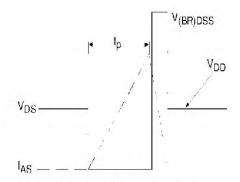


Fig 12b. Unclamped Inductive Waveforms

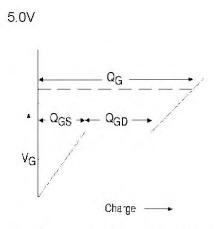
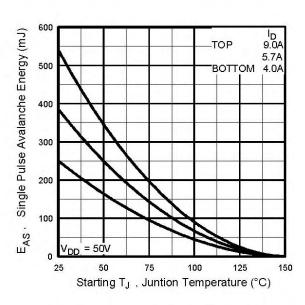


Fig 13a. Basic Gate Charge Waveform

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**Fig 12c.** Maximum Avalanche Energy Vs. Drain Current

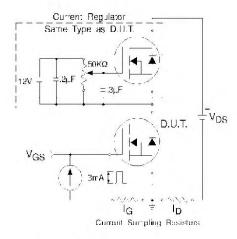
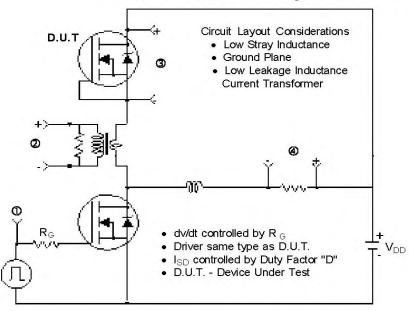


Fig 13b. Gate Charge Test Circuit

## Peak Diode Recovery dv/dt Test Circuit



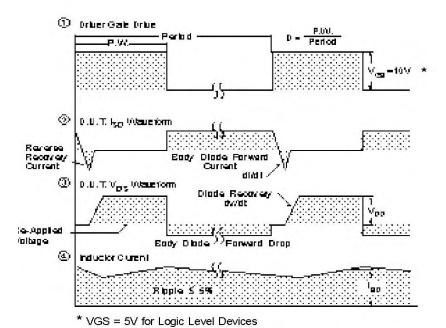


Fig 14. For N-Channel HEXFETS

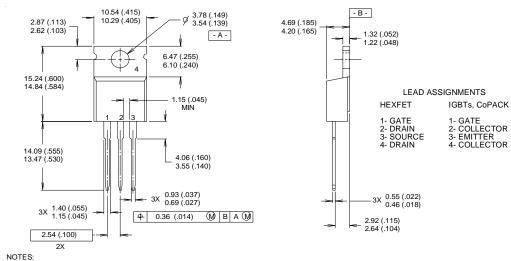
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## IRL630PbF

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### TO-220AB Package Outline

Dimensions are shown in millimeters (inches)



- 1 DIMENSIONING & TOLERANCING PER ANSI Y14.5M, 1982.
- 2 CONTROLLING DIMENSION : INCH
- 3 OUTLINE CONFORMS TO JEDEC OUTLINE TO-220AB.
- 4 HEATSINK & LEAD MEASUREMENTS DO NOT INCLUDE BURRS.

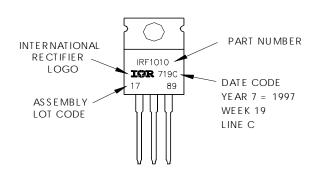
### TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF 1010

LOT CODE 1789

ASSEMBLED ON WW 19, 1997 IN THE ASSEMBLY LINE "C"

Note: "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.



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